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Vishay Siliconix

# P-Channel 100 V (D-S) MOSFET



PRODUCT SUMMARY					
V <sub>DS</sub> (V)	-100				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -10 V	0.132				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -4.5 \text{ V}$	0.186				
Q <sub>g</sub> typ. (nC)	5.65				
I <sub>D</sub> (A) <sup>g</sup>	10.8				
Configuration	Single				

#### **FEATURES**

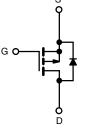
- TrenchFET® power MOSFET
- 100 % R<sub>g</sub> and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS COMPLIANT HALOGEN FREE

### **APPLICATIONS**

- · Active clamp in intermediate DC/DC power supplies
- LED Lighting
- · Load switch



P-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK 1212-8
Lead (Pb)-free and halogen-free	Si7113ADN-T1-GE3

PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		$V_{DS}$	-100	V
Gate-source voltage		$V_{GS}$	± 20	V
	T <sub>C</sub> = 25 °C		-10.8	
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 70 °C	Ī , [	-8.6	
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	-3.8 <sup>b, c</sup>	
	T <sub>A</sub> = 70 °C		-3.1 <sup>b, c</sup>	^
Pulsed drain current (t = 100 µs)		I <sub>DM</sub>	-20	A
Continuous source-drain diode current	T <sub>C</sub> = 25 °C		-16 <sup>a</sup>	
	T <sub>A</sub> = 25 °C	ls l	-2.9 <sup>b, c</sup>	
Single pulse avalanche current	. 0.1!!	I <sub>AS</sub>	-15	
Single pulse avalanche energy  L = 0.1 mH		E <sub>AS</sub>	11.25	mJ
	T <sub>C</sub> = 25 °C		27.8	
Maniana and a displanting	T <sub>C</sub> = 70 °C		17.8	14/
Maximum power dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3.5 <sup>b, c</sup>	W
	T <sub>A</sub> = 70 °C	1	2.2 <sup>b, c</sup>	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stq</sub>	-55 to +150	°C
Soldering recommendations (peak temperature) d, e			260	

THERMAL RESISTANCE RATING	S				
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient b, f	t ≤ 10 s	R <sub>thJA</sub>	29	36	°C/W
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	3.6	4.6	C/VV

#### **Notes**

- Package limited
  Surface mounted on 1" x 1" FR4 board
- See solder profile (<a href="www.vishay.com/doc?73257">www.vishay.com/doc?73257</a>). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

  Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

  Maximum under steady state conditions is 81 °C/W

- $T_C = 25 \, ^{\circ}C$

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		'				
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-100	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$		-	-63	-	\//00
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = -250 μA	-	4.2	-	mV/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-1.1	-	-2.6	V
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
7		V <sub>DS</sub> = -100 V, V <sub>GS</sub> = 0 V	-	-	-1	_
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = -100 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 70 °C	-	-	-10	μA
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge -10 \text{ V}, V_{GS} = -10 \text{ V}$	-15	-	-	Α
Duning and the second of the s	_	$V_{GS} = -10 \text{ V}, I_D = -3.8 \text{ A}$	-	0.110	0.132	0
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -3.2 A	-	0.155	0.186	Ω
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = -10 \text{ V}, I_D = -3.8 \text{ A}$	-	8	-	S
Dynamic <sup>b</sup>				•		
Input capacitance	C <sub>iss</sub>		-	515	-	
Output capacitance	C <sub>oss</sub>	$V_{DS} = -50 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	162	-	рF
Reverse transfer capacitance	C <sub>rss</sub>		-	10	-	1
Total gate shares	0	$V_{DS} = -50 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -3.8 \text{ A}$	-	10.9	16.5	
Total gate charge	$Q_g$		-	5.65	8.5	1
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = -50 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -3.8 \text{ A}$	-	1.7	-	nC
Gate-drain charge	$Q_{gd}$		-	2.5	-	
Gate resistance	R <sub>g</sub>	f = 1 MHz	1.96	9.8	19.6	Ω
Turn-on delay time	t <sub>d(on)</sub>		-	10	20	
Rise time	t <sub>r</sub>	$V_{DD} = -50 \text{ V}, R_L = 16.1 \Omega, I_D \cong -3.1 \text{ A},$	-	22	40	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN}$ = -10 V, $R_g$ = 1 $\Omega$	-	20	40	
Fall time	t <sub>f</sub>		-	20	40	1
Turn-on delay time	t <sub>d(on)</sub>		-	35	55	ns
Rise time	t <sub>r</sub>	$V_{DD} = -50 \text{ V}, R_L = 16.1 \Omega, I_D \cong -3.1 \text{ A},$	-	40	60	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN}$ = -4.5 V, $R_g$ = 1 $\Omega$	-	22	40	1
Fall time	t <sub>f</sub>		-	1622	40	
<b>Drain-Source Body Diode Characterist</b>	ics					
Continuous source-drain diode current	Is	T <sub>C</sub> = 25 °C	-	-	-16	_
Pulse diode forward current	I <sub>SM</sub>		-	-	-15	A
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = -3.1 A, V <sub>GS</sub> = 0 V	-	-0.8	-1.2	V
Body diode reverse recovery time	t <sub>rr</sub>		-	43	65	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	]	-	80	120	nC
Reverse recovery fall time	t <sub>a</sub>	$I_F = -3.1 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s, T}_J = 25 ^{\circ}\text{C}$	-	36	-	
Reverse recovery rise time	t <sub>b</sub>	1	_	7	-	ns

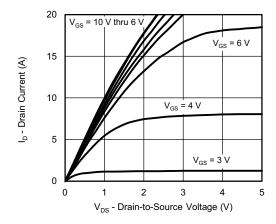
#### **Notes**

- a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing

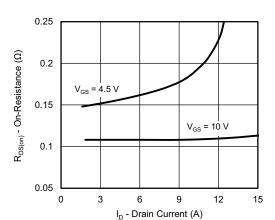
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



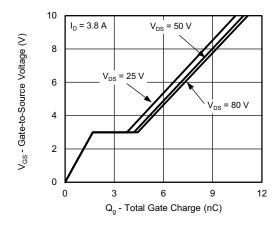
# TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



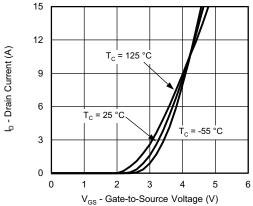
### **Output Characteristics**



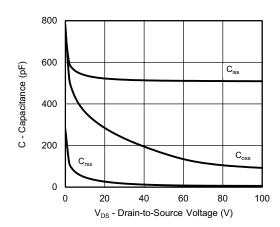
On-Resistance vs. Drain Current and Gate Voltage



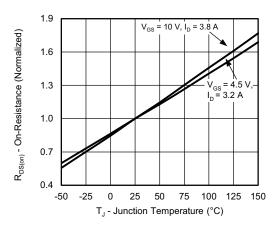
**Gate Charge** 



**Transfer Characteristics** 



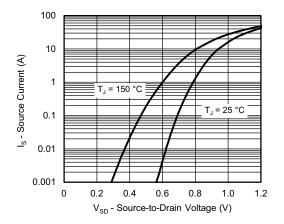
Capacitance



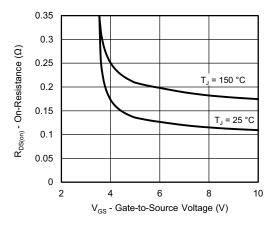
On-Resistance vs. Junction Temperature



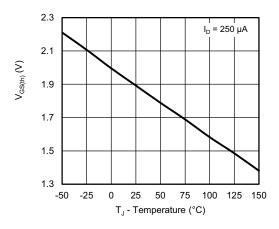
# TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



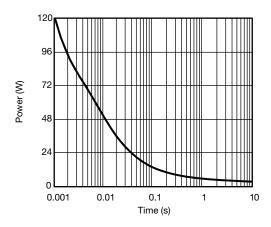
Source-Drain Diode Forward Voltage



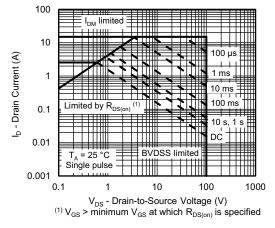
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 



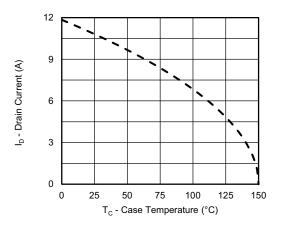
Single Pulse Power, Junction-to-Ambient



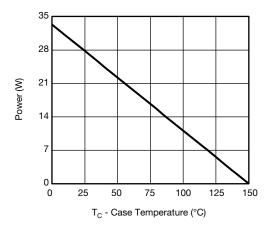
Safe Operating Area, Junction-to-Ambient

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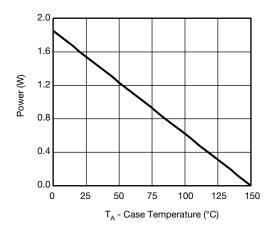
# TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



### Current Derating a







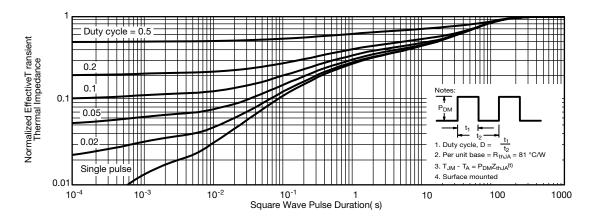
Power, Junction-to-Ambient

### Note

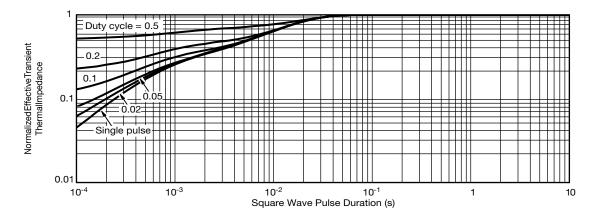
a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



# TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



### Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?77678">www.vishay.com/ppg?77678</a>.



# PowerPAK® 1212-8, (Single / Dual)





#### Notes

- 1. Inch will govern
- 2 Dimensions exclusive of mold gate burrs 3. Dimensions exclusive of mold flash and cutting burrs



Backside view of dual pad

DIM.	MILLIMETERS		INCHES			
DIIVI.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
Α	0.97	1.04	1.12	0.038	0.041	0.044
A1	0.00	-	0.05	0.000	-	0.002
b	0.23	0.30	0.41	0.009	0.012	0.016
С	0.23	0.28	0.33	0.009	0.011	0.013
D	3.20	3.30	3.40	0.126	0.130	0.134
D1	2.95	3.05	3.15	0.116	0.120	0.124
D2	1.98	2.11	2.24	0.078	0.083	0.088
D3	0.48	-	0.89	0.019	-	0.035
D4	0.47 typ.			0.0185 typ		
D5		2.3 typ.			0.090 typ	
E	3.20	3.30	3.40	0.126	0.130	0.134
E1	2.95	3.05	3.15	0.116	0.120	0.124
E2	1.47	1.60	1.73	0.058	0.063	0.068
E3	1.75	1.85	1.98	0.069	0.073	0.078
E4		0.034 typ.		0.013 typ.		
е		0.65 BSC		0.026 BSC		
K		0.86 typ.		0.034 typ.		
K1	0.35	-	-	0.014	-	-
Н	0.30	0.41	0.51	0.012	0.016	0.020
L	0.30	0.43	0.56	0.012	0.017	0.022
L1	0.06	0.13	0.20	0.002	0.005	0.008
θ	0°	-	12°	0°	-	12°
W	0.15	0.25	0.36	0.006	0.010	0.014
М		0.125 typ.	0.125 typ. 0.005 typ.			

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Document Number: 71656



# RECOMMENDED MINIMUM PADS FOR PowerPAK® 1212-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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